

Product Overview

Description

The SG79xxA/SG79xx series of negative regulators offer self-contained, fixed voltage capability with up to 1.5A of load current and input voltage up to -30V. With a variety of output voltages this regulator series is an optimum complement to the SG7800A/SG7800 positive three terminal regulators.

These units feature a unique band gap reference which allows the SG79xxA series to be specified with an output voltage tolerance of $\pm 1.5\%$. The SG79xxA versions also offer much improved line regulation characteristics.

All protective features of thermal shutdown, current limiting, and safe-area control have been designed into these units and since these regulators require only a single output capacitor (SG79xx series) or a capacitor and 5mA minimum load (SG120 series) for satisfactory performance, ease of application is assured.

Although designed as fixed-voltage regulators, the output voltage can be increased through the use of a simple voltage divider. The low quiescent drain current of the device insures good regulation when this method is used. These devices are available in hermetically sealed TO-257 (both case grounded 'G' and isolated 'IG'), TO-3, TO-39, and LCC packages.

Features

- Output voltage set internally to $\pm 1.5\%$ on SG79xxA
- Output current up to 1.5A
- Excellent line and load regulation
- Foldback current limiting
- Thermal overload protection
- Voltages available: -5V, -12V, -15V
- Contact factory for other voltage options
- Available in surface mount package

High Reliability Features

- Available to MIL-STD - 883, ¶ 1.2.1
- MIL-M38510/11501BXA - SG7905T-JAN
- MIL-M38510/11505BYA - SG7905K-JAN
- MIL-M38510/11502BXA - SG7912T-JAN
- MIL-M38510/11506BYA - SG7912K-JAN
- MIL-M38510/11503BXA - SG7915T-JAN
- MIL-M38510/11507BYA - SG7915K-JAN
- MIL-M38510/11508BYA - SG7924K-JAN
- Level "S" processing available
- Available to DLA Standard Microcircuit Drawing (SMD)

Figure 1. Schematic Diagram

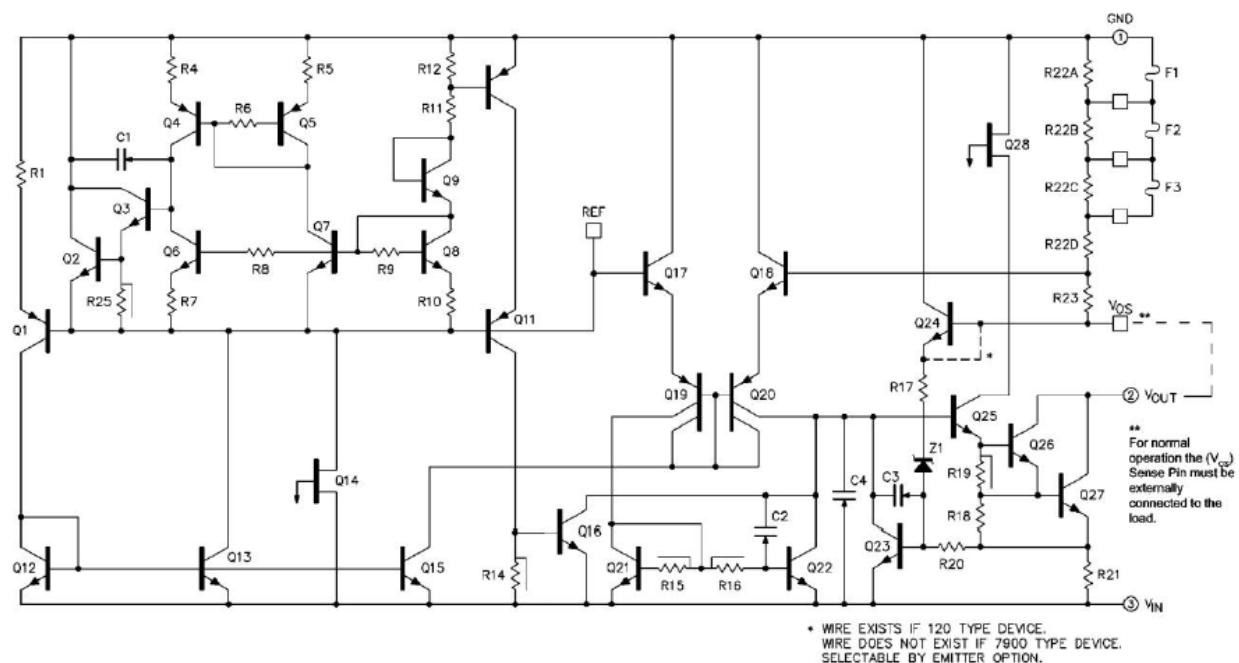


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1. Maximum Ratings

Table 1-1. Maximum Ratings¹

Parameter	Value	Units
Device output voltage	-5, -12, -15	V
Input voltage	-35, -40 ($V_{OUT} \leq -15V$)	V
Input voltage differential (output shorted to ground)	35	V
Operating junction temperature	150	°C
Storage temperature range	-65 to 150	°C
Lead temperature (soldering 10 seconds)	300	°C

Note:

- Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

1.1 Thermal Data

Table 1-2. Thermal Data¹⁻²

Parameter	Value	Units
K Package TO-3 3-Pin Metal Can		
Thermal resistance-junction to case, θ_{JC}	3	°C/W
Thermal resistance-junction to ambient, θ_{JA}	35	°C/W
T Package TO-39 3-Pin Metal Can		
Thermal resistance-junction to case, θ_{JC}	15	°C/W
Thermal resistance-junction to ambient, θ_{JA}	120	°C/W
G Package TO-257 3-Pin Hermetic		
Thermal resistance-junction to case, θ_{JC}	3.5	°C/W
Thermal resistance-junction to ambient, θ_{JA}	42	°C/W
IG Package TO-257 3-Pin Hermetic (Isolated)		
Thermal resistance-junction to case, θ_{JC}	4	°C/W
Thermal resistance-junction to ambient, θ_{JA}	42	°C/W
L Package Leadless Chip Carrier 20-Pin Ceramic		
Thermal resistance-junction to case, θ_{JC}	35	°C/W
Thermal resistance-junction to ambient, θ_{JA}	120	°C/W

Notes:

- Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.
- The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.

2. Characteristics Curves

Figure 2-1. Maximum Average Power Dissipation

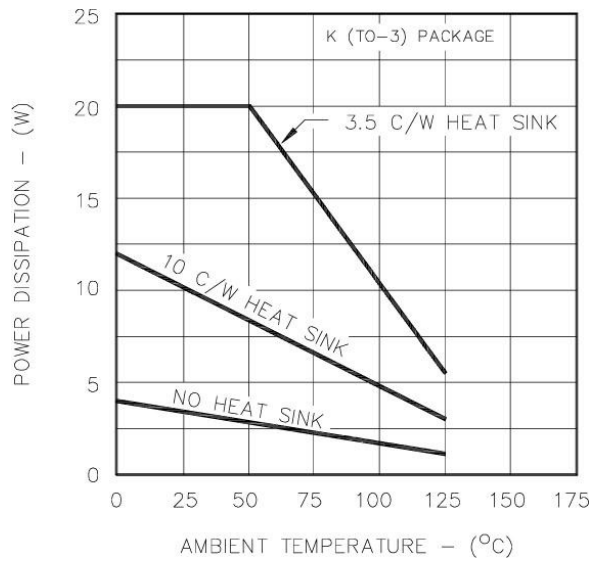


Figure 2-2. Quiescent Current Vs. Load

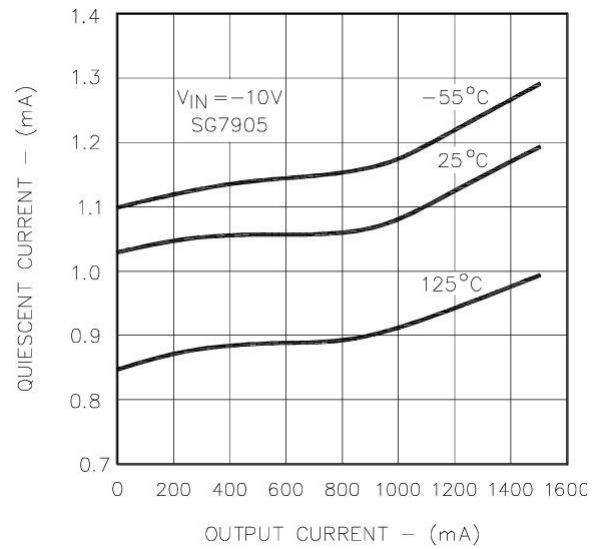


Figure 2-3. Temperature Coefficient

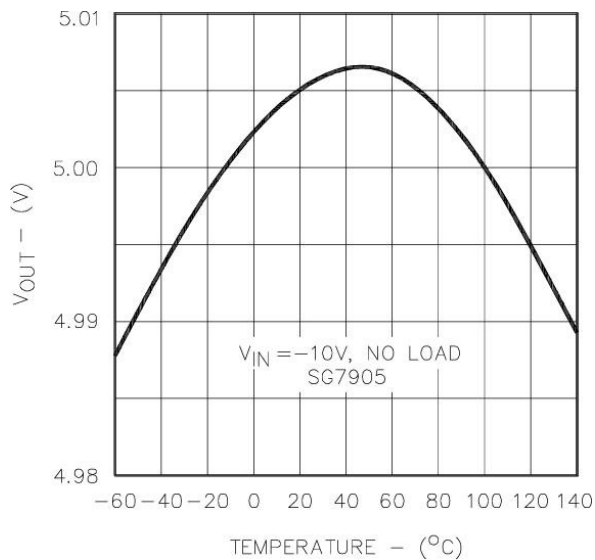


Figure 2-4. Short-Circuit Current Vs. V_{IN}

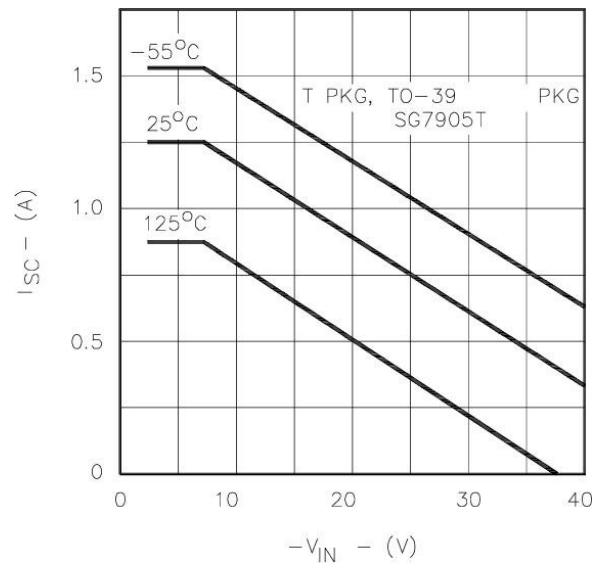


Figure 2-5. Quiescent Current Vs. V_{IN}

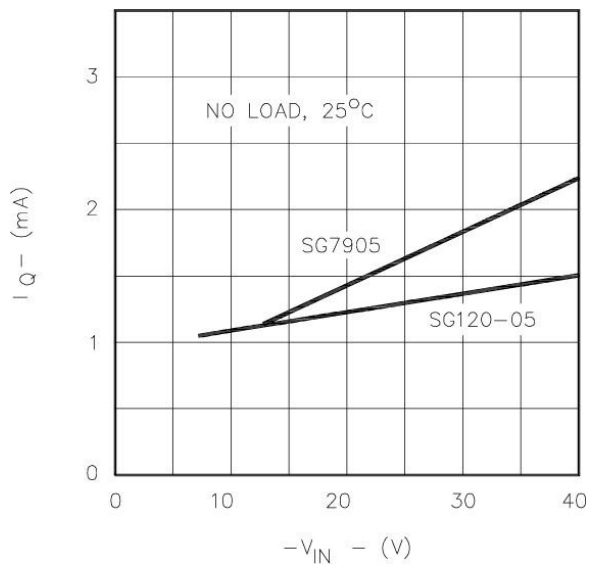


Figure 2-6. Short-Circuit Current Vs. V_{IN}

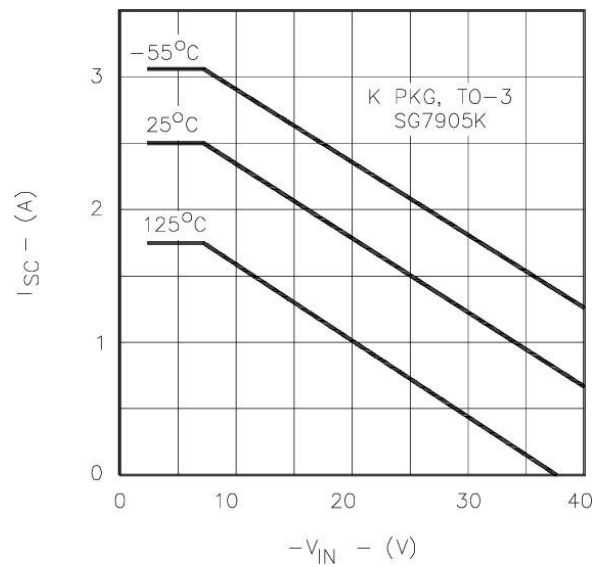


Figure 2-7. Dropout Characteristics

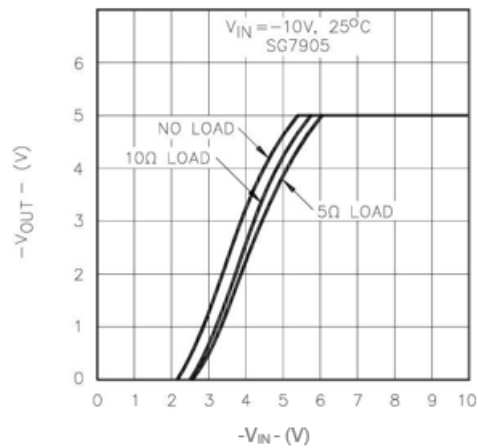
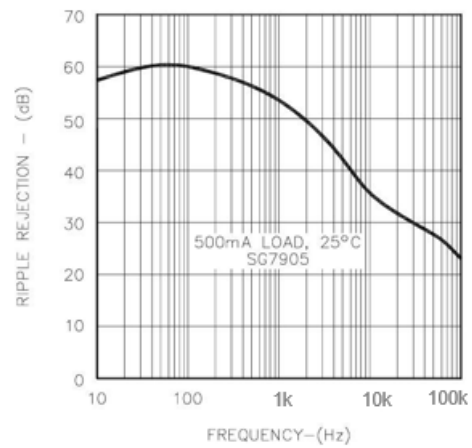
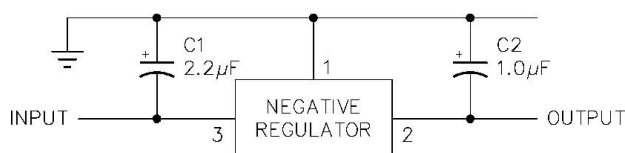


Figure 2-8. Ripple Rejection Vs. Frequency



3. Application Information

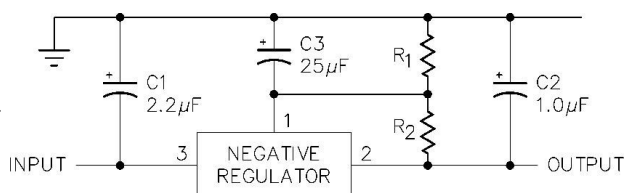
Figure 3-1. Fixed Output Regulator



Notes:

1. C1 is required only if regulator is separated from rectifier filter.
2. Both C1 and C2 should be low E.S.R. types such as solid tantalum. If aluminum electrolytic capacitors are used, at least 10 times values shown should be selected.
3. If large output capacities are used, the regulators must be protected from momentary input shorts. A high current diode is indicated from output to input.

Figure 3-2. Circuit for Increasing Output Voltage



Note:

1. C3 optional for improved transient response and ripple rejection.

$$V_{OUT} = V(\text{REGULATOR}) \frac{R_1 + R_2}{R_1}$$

$$R_2 = \frac{V(\text{REG})}{15\text{mA}}$$

3.1 Recommended Operating Conditions

Table 3-1. Recommended Operating Conditions

Parameter	SG79xx / 79xxA			Units
	Min.	Typ.	Max.	
Operating Junction Temperature Range ¹	-55	—	150	°C

Note:

1. Range over which the device is functional.

4. Electrical Characteristics

Unless otherwise specified, these specifications apply over the operating ambient temperatures for SG7905A/SG7905 with $-55\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$, $V_{IN} = -10\text{V}$, $I_O = 500\text{ mA}$ for the K, G, and IG-Power Packages, $I_O = 100\text{ mA}$ for the T and L packages, $C_{IN} = 2\text{ }\mu\text{F}$, and $C_{OUT} = 1\text{ }\mu\text{F}$. Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.

Table 4-1. Electrical Characteristics for SG7905A/SG7905

Parameter	Test Conditions	SG7905A			SG7905			Units
		Min.	Typ.	Max.	Min.	Typ.	Max.	
Output voltage	$T_J = 25\text{ }^{\circ}\text{C}$	-4.95	-5.00	-5.05	-4.80	-5.00	-5.20	V
Line regulation ¹	$V_{IN} = -7.5\text{V to } -25\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	5	25	—	3	50	mV
	$V_{IN} = -8\text{V to } -12\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	3	12	—	1	25	mV
Load regulation ¹	Power packages: $I_O = 5\text{ mA to } 1.5\text{A}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	15	75	—	15	100	mV
	$I_O = 250\text{ mA to } 750\text{ mA}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	15	25	—	15	25	mV
	T-Package: $I_O = 5\text{ mA to } 500\text{ mA}$, $T_J = 250\text{ }^{\circ}\text{C}$	—	5	30	—	5	100	mV
Total output voltage tolerance	$V_{IN} = -8\text{V to } -20\text{V}$ Power packages: $I_O = 5\text{ mA to } 1.0\text{A}$, $P \leq 20\text{W}$	-4.85	-5.00	-5.15	-4.70	-5.00	-5.30	V
	$V_{IN} = -8\text{V to } -20\text{V}$ T-Package: $I_O = 5\text{ mA to } 500\text{ mA}$, $P \leq 20\text{W}$	-4.85	-5.00	-5.15	-4.70	-5.00	-5.30	V
Quiescent current	Over Temperature Range	—	—	2.5	—	—	2.5	mA
	$T_J = 25\text{ }^{\circ}\text{C}$	—	—	2.0	—	—	2.0	mA
Quiescent current change	With line: $V_{IN} = -8\text{V to } -25\text{V}$	—	—	1.3	—	—	1.3	mA
	With load: $I_O = 5\text{ mA to } 1.0\text{A}$ (Power Packages.)	—	—	0.5	—	—	0.5	mA
	$I_O = 5\text{ mA to } 500\text{ mA}$ (T)	—	—	0.5	—	—	0.5	mA
Dropout voltage	$\Delta V_O = 100\text{ mV}$, $T_J = 25\text{ }^{\circ}\text{C}$ Power packages: $I_O = 1.0\text{A}$, T-Package: $I_O = 500\text{ mA}$	—	1.1	2.3	—	1.1	2.3	V
Peak output current	Power packages: $T_J = 25\text{ }^{\circ}\text{C}$	1.5	—	3.3	1.5	—	3.3	A
	T-Package: $T_J = 25\text{ }^{\circ}\text{C}$	0.5	—	1.4	0.5	—	1.4	A
Short circuit current	Power packages: $V_{IN} = -35\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	—	1.2	—	—	1.2	A
	T-Package: $V_{IN} = -35\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	—	0.6	—	—	0.6	A
Ripple rejection	$\Delta V_{IN} = 10\text{V}$, $f = 120\text{ Hz}$, $T_J = 25\text{ }^{\circ}\text{C}$	54	—	—	54	—	—	dB
Output noise voltage (rms) ²	$f = 10\text{ Hz to } 100\text{ kHz}$	—	25	80	—	25	80	$\mu\text{V/V}$
Long term stability	1000 hours at $T_J = 125\text{ }^{\circ}\text{C}$	—	20	—	—	20	—	mV
Thermal shutdown	$I_O = 5\text{ mA}$	—	175	—	—	175	—	$^{\circ}\text{C}$

Notes:

1. All regulation tests are made at constant junction temperature with low duty cycle testing.
2. This test is guaranteed but is not tested in production.

Unless otherwise specified, these specifications apply over the operating ambient temperatures for SG7912A/SG7912 with $-55\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$, $V_{IN} = -19\text{V}$, $I_O = 500\text{ mA}$ for the K, G, and IG-Power Packages, $I_O = 100\text{ mA}$ for the T and L packages, $C_{IN} = 2\text{ }\mu\text{F}$, and $C_{OUT} = 1\text{ }\mu\text{F}$. Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.

Table 4-2. Electrical Characteristics for SG7912A/SG7912

Parameter	Test Conditions	SG7912A			SG7912			Units
		Min.	Typ.	Max.	Min.	Typ.	Max.	
Output voltage	$T_J = 25\text{ }^{\circ}\text{C}$	-11.8	-12.0	-12.2	-11.5	-12.0	-12.5	V
Line regulation ¹	$V_{IN} = -14.5\text{V to } -30\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	4	60	—	10	120	mV
	$V_{IN} = -16\text{V to } -22\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	3	30	—	3	60	mV
Load regulation ¹	Power packages: $I_O = 5\text{ mA to } 1.5\text{A}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	20	90	—	12	120	mV
	$I_O = 250\text{ mA to } 750\text{ mA}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	10	40	—	10	60	mV
	T-Package: $I_O = 5\text{ mA to } 500\text{ mA}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	10	40	—	10	240	mV
Total output voltage tolerance	$V_{IN} = -14.5\text{V to } -27\text{V}$ Power packages: $I_O = 5\text{ mA to } 1.0\text{A}$, $P \leq 20\text{W}$	-11.7	-12.0	-12.3	-11.4	-12.0	-12.6	V
	$V_{IN} = -14.5\text{V to } -27\text{V}$ T-Package: $I_O = 5\text{ mA to } 500\text{ mA}$, $P \leq 2\text{W}$	-11.7	-12.0	-12.3	-11.4	-12.0	-12.6	V
Quiescent current	Over Temperature Range	—	—	4	—	—	4	mA
	$T_J = 25\text{ }^{\circ}\text{C}$	—	—	3	—	—	3	mA
Quiescent current change	With line: $V_{IN} = -14.5\text{V to } -30\text{V}$	—	—	1.0	—	—	1.0	mA
	With load: $I_O = 5\text{ mA to } 1.0\text{A}$ (power packages.)	—	—	0.5	—	—	0.5	mA
	$I_O = 5\text{ mA to } 500\text{ mA}$ (T)	—	—	0.5	—	—	0.5	mA
Dropout voltage	$\Delta V_O = 100\text{ mV}$, $T_J = 25\text{ }^{\circ}\text{C}$ Power packages: $I_O = 1.0\text{A}$, T-Package: $I_O = 500\text{ mA}$	—	1.1	2.3	—	1.1	2.3	V
Peak output current	Power packages: $T_J = 25\text{ }^{\circ}\text{C}$	1.5	—	3.3	1.5	—	3.3	A
	T-Package: $T_J = 25\text{ }^{\circ}\text{C}$	0.5	—	1.4	0.5	—	1.4	A
Short circuit current	Power packages: $V_{IN} = -35\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	—	1.2	—	—	0.2	A
	T-Package: $V_{IN} = -35\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	—	0.6	—	—	0.6	A
Ripple rejection	$\Delta V_{IN} = 10\text{V}$, $f = 120\text{ Hz}$, $T_J = 25\text{ }^{\circ}\text{C}$	54	—	—	54	—	—	dB
Output noise voltage (rms) ²	$f = 10\text{ Hz to } 100\text{ kHz}$	—	25	80	—	25	80	$\mu\text{V/V}$
Long term stability	1000 hours at $T_J = 125\text{ }^{\circ}\text{C}$	—	60	—	—	60	—	mV
Thermal shutdown	$I_O = 5\text{ mA}$	—	175	—	—	175	—	$^{\circ}\text{C}$

Notes:

1. All regulation tests are made at constant junction temperature with low duty cycle testing.
2. This test is guaranteed but is not tested in production.

Unless otherwise specified, these specifications apply over the operating ambient temperatures for SG7915A / SG7915 with $-55\text{ }^{\circ}\text{C} \leq T_A \leq 125\text{ }^{\circ}\text{C}$, $V_{IN} = -23\text{V}$, $I_O = 500\text{ mA}$ for the K, G, and IG-Power Packages, $I_O = 100\text{ mA}$ for the T and L packages, $C_{IN} = 2\text{ }\mu\text{F}$, and $C_{OUT} = 1\text{ }\mu\text{F}$. Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.

Table 4-3. Electrical Characteristics for SG7915A/SG7915

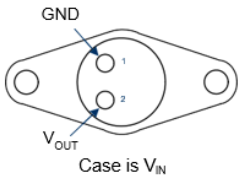
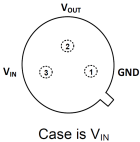
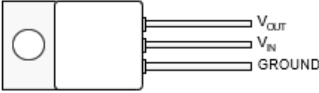
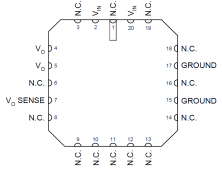
Parameter	Test Conditions	SG7915A			SG7915			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
Output voltage	$T_J = 25\text{ }^{\circ}\text{C}$	-14.8	-15.0	-15.2	-14.4	-15.0	-15.6	V
Line regulation ¹	$V_{IN} = -17.5\text{V to } -30\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	5	75	—	11	150	mV
	$V_{IN} = -20\text{V to } -25\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	3	40	—	3	75	mV
Load regulation ¹	Power packages: $I_O = 5\text{ mA to } 1.5\text{A}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	30	100	—	12	150	mV
	$I_O = 250\text{ mA to } 750\text{ mA}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	4	50	—	4	75	mV
	T-Package: $I_O = 5\text{ mA to } 500\text{ mA}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	10	50	—	10	240	mV
Total output voltage tolerance	$V_{IN} = -18.5\text{V to } -30\text{V}$ Power packages: $I_O = 5\text{ mA to } 1.0\text{A}$, $P \leq 20\text{W}$	-14.6	-15.0	-15.4	-14.25	-15.00	-15.75	V
	$V_{IN} = -18.5\text{V to } -30\text{V}$ T-Package: $I_O = 5\text{ mA to } 500\text{ mA}$, $P \leq 2\text{W}$	-14.6	-15.0	-15.4	-14.25	-15.00	-15.75	V
Quiescent current	Over Temperature Range	—	—	4	—	—	4	mA
	$T_J = 25\text{ }^{\circ}\text{C}$	—	—	3	—	—	3	mA
Quiescent current change	With line: $V_{IN} = -18.5\text{V to } -30\text{V}$	—	—	1.0	—	—	1.0	mA
	With load: $I_O = 5\text{ mA to } 1.0\text{A}$ (power packages)	—	—	0.5	—	—	0.5	mA
	$I_O = 5\text{ mA to } 500\text{ mA}$ (T)	—	—	0.5	—	—	0.5	mA
Dropout voltage	$\Delta V_O = 100\text{ mV}$, $T_J = 25\text{ }^{\circ}\text{C}$ Power packages: $I_O = 1.0\text{A}$, T-Package: $I_O = 500\text{ mA}$	—	1.1	2.3	—	1.1	2.3	V
Peak output current	Power Packages: $T_J = 25\text{ }^{\circ}\text{C}$	1.5	—	3.3	1.5	—	3.3	A
	T-Package: $T_J = 25\text{ }^{\circ}\text{C}$	0.5	—	1.4	0.5	—	1.4	A
Short circuit current	Power Packages: $V_{IN} = -35\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	—	1.2	—	—	1.2	A
	T-Package: $V_{IN} = -35\text{V}$, $T_J = 25\text{ }^{\circ}\text{C}$	—	—	0.6	—	—	0.6	A
Ripple rejection	$\Delta V_{IN} = 10\text{V}$, $f = 120\text{ Hz}$, $T_J = 25\text{ }^{\circ}\text{C}$	54	—	—	54	—	—	dB
Output noise voltage (rms) ²	$f = 10\text{ Hz to } 100\text{ kHz}$	—	25	80	—	25	80	$\mu\text{V/V}$
Long term stability	1000 hours at $T_J = 125\text{ }^{\circ}\text{C}$	—	60	—	—	60	—	mV
Thermal shutdown	$I_O = 5\text{ mA}$	—	175	—	—	175	—	$^{\circ}\text{C}$

Notes:

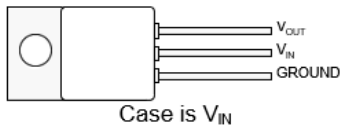
1. All regulation tests are made at constant junction temperature with low duty cycle testing.
2. This test is guaranteed but is not tested in production.

5. Connection Diagrams and Ordering Information

Table 5-1. Connection Diagrams and Ordering Information¹⁻⁴

Package	Part No.	Ambient Temperature Range	Connection Diagram
3-Terminal TO-3 Metal Can K-Package	SG79xxAK-883B	-55°C to 125°C	
	SG7905AK-DESC	-55°C to 125°C	
	SG7912AK-DESC	-55°C to 125°C	
	SG7915AK-DESC	-55°C to 125°C	
	SG79xxAK	-55°C to 125°C	
	SG79xxK-883B	-55°C to 125°C	
	SG7905K-JAN	-55°C to 125°C	
	SG7912K-JAN	-55°C to 125°C	
	SG7915K-JAN	-55°C to 125°C	
	SG79xxK	-55°C to 125°C	
3-Pin TO-39 Metal Can T-Package	SG79xxAT-883B	-55°C to 125°C	
	SG7905AT-DESC	-55°C to 125°C	
	SG7912AT-DESC	-55°C to 125°C	
	SG7915AT-DESC	-55°C to 125°C	
	SG79xxAT	-55°C to 125°C	
	SG79xxT-883B	-55°C to 125°C	
	SG7905T-JAN	-55°C to 125°C	
	SG7912T-JAN	-55°C to 125°C	
	SG7915T-JAN	-55°C to 125°C	
	SG79xxT	-55°C to 125°C	
3-Pin Hermetic TO-257 IG - Package (Isolated)	SG79xxAIG-883B	-55°C to 125°C	
	SG7905AIG-DESC	-55°C to 125°C	
	SG7912AIG-DESC	-55°C to 125°C	
	SG7915AIG-DESC	-55°C to 125°C	
	SG79xxAIG	-55°C to 125°C	
	SG79xxIG-883B	-55°C to 125°C	
	SG79xxIG	-55°C to 125°C	
20-Pin Ceramic Leadless Chip Carrier ⁵⁻⁶ L - Package	SG79xxL-883B	-55°C to 125°C	
	SG79xxL	-55°C to 125°C	
	SG7905AL-DESC	-55°C to 125°C	
	SG7912AL-DESC	-55°C to 125°C	
	SG7915AL-DESC	-55°C to 125°C	

.....continued

Package	Part No.	Ambient Temperature Range	Connection Diagram
3-Pin Hermetic TO-257 G – Package (Case is V_{IN})	SG7905AG-DESC	-55°C to 125°C	
	SG7912AG-DESC	-55°C to 125°C	

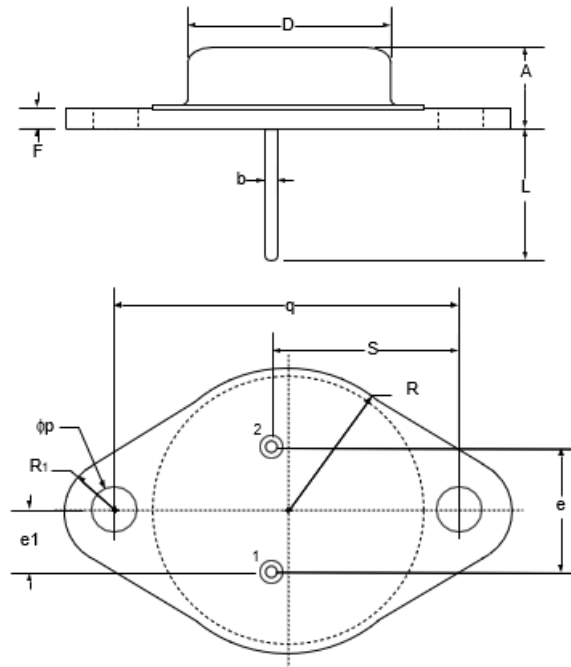
Notes:

1. Contact factory for JAN and DESC product availability.
2. All parts are viewed from the top.
3. "xx" to be replaced by output voltage of specific fixed regulator.
4. Some products will be available in hermetic flat pack (F). Consult factory for price and availability.
5. Both inputs and outputs must be externally connected together at the device terminals.
6. For normal operation, the V_O SENSE pin must be externally connected to the load.

6. Package Outline Dimensions

Controlling dimensions are in inches; metric equivalents are shown for general information.

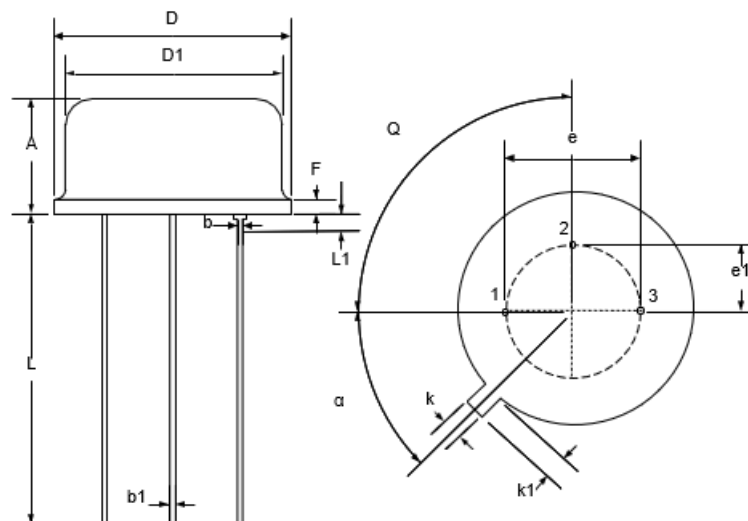
Figure 6-1. K 3-Pin Metal Can TO-3



Dim. ¹	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	6.86	7.62	0.270	0.300
q	29.90	30.40	1.177	1.197
b	0.97	1.09	0.038	0.043
D	19.43	19.68	0.765	0.775
S	16.64	17.14	0.655	0.675
e	10.67	11.18	0.420	0.440
e1	5.21	5.72	0.205	0.225
F	1.52	2.03	0.060	0.080
φp	3.84	4.09	0.151	0.161
L	10.79	12.19	0.425	0.480
R1	3.33	4.78	0.131	0.188
R	12.57	13.34	0.495	0.525

Note:

1. Dimensions do not include protrusions; these shall not exceed 0.155 mm (0.006") on any side. Lead dimension shall not include solder coverage.

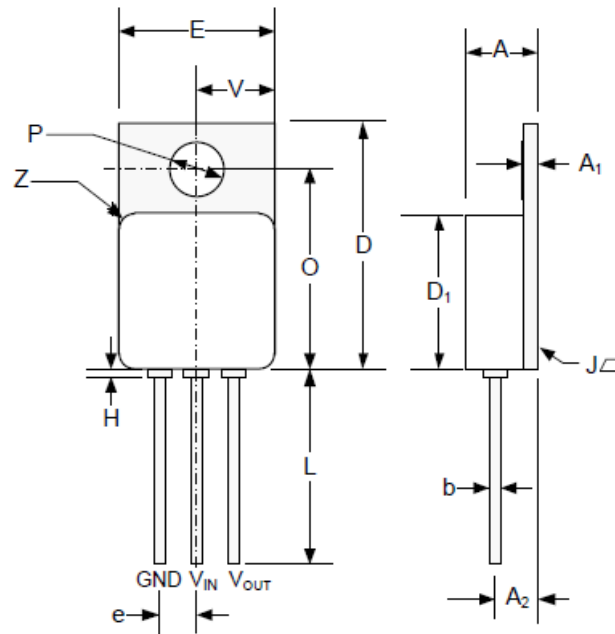
Figure 6-2. T 3-Pin Metal Can TO-39


Dim. ¹	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.19	4.70	0.165	0.185
b	0.41	0.48	0.016	0.019
b1	0.41	0.53	0.016	0.021
D	8.89	9.40	0.350	0.370
D1	8.13	8.51	0.320	0.335
e	5.08 BSC		0.200 BSC	
e1	2.54 Typ		0.100 Typ	
F	—	1.02	—	0.040
k	0.71	0.86	0.028	0.034
k1	0.74	1.14	0.029	0.045
L	12.70	14.48	0.500	0.570
L1	—	1.27	—	0.050
Q	90° Typ		90° Typ	
α	45° Typ		45° Typ	

Note:

1. Dimensions do not include protrusions; these shall not exceed 0.155 mm (0.006") on any side. Lead dimension shall not include solder coverage.

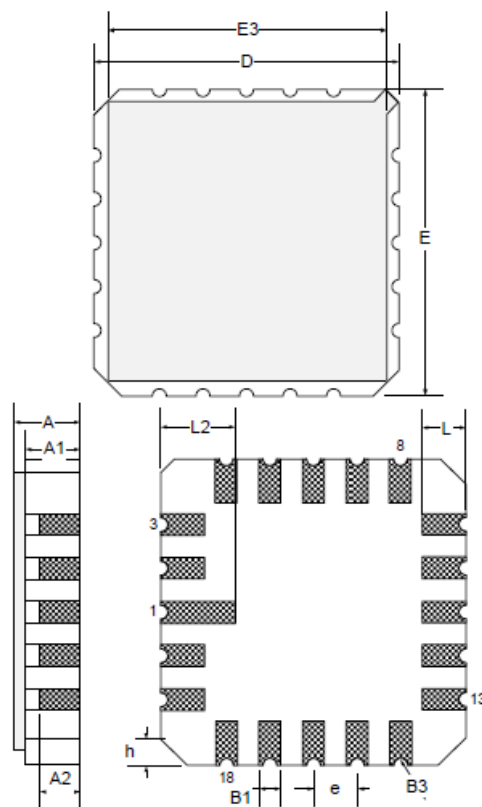
Figure 6-3. G/IG 3-Pin Hermetic TO-257



Dim. ¹	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.70	5.21	0.185	0.205
A1	0.89	1.14	0.035	0.045
A2	2.92	3.18	0.115	0.125
b	0.71	0.081	0.027	0.032
D	16.38	16.76	0.645	0.660
D1 ²	10.41	10.92	0.410	0.430
e	2.54 BSC		0.100 BSC	
E ²	10.41	10.67	0.410	0.420
H	—	0.50	—	0.020
L	12.70		0.500	
O	13.39	13.64	0.527	0.537
P	3.56	3.81	0.140	0.150
J	—	0.10	—	0.004
V	5.13	5.38	0.202	0.212
Z	1.40 Typ		0.055 Typ	

Notes:

1. Dimensions do not include protrusions; these shall not exceed 0.155 mm (0.006") on any side. Lead dimension shall not include solder coverage.
2. Excludes Weld Fillet Around Lid.

Figure 6-4. L 20-Pin Ceramic Leadless Chip Carrier

Dim. ¹	Millimeters		Inches	
	Min.	Max.	Min.	Max.
D, E	8.64	9.14	0.340	0.360
E3	—	8.128	—	0.320
e	1.270 BSC		0.050 BSC	
B1	0.635 Typ		0.025 Typ	
L	1.02	1.52	0.040	0.060
A	1.626	2.286	0.064	0.090
h	1.016 Typ		0.040 Typ	
A1	1.372	1.68	0.054	0.066
A2	—	1.168	—	0.046
L2	1.91	2.41	0.075	0.95
B3	0.203R		0.008R	

Note:

1. All exposed metalized area shall be gold plated 60 μ -inch minimum thickness over nickel plated unless specified in purchase order. Lead dimension shall not include solder coverage.

7. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

Revision	Date	Description
A	07/2024	Document was converted to Microchip template.
1.7	01/2015	Initial Microsemi document.

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